

SID

Factory: Rot am See

Article:

ML10

Provided:

Customer:

Date:

23.04.2026

WÜRTH
ELEKTRONIK
MORE THAN
YOU EXPECT

Processtechnology: B: undefined

Material Text	Mat. Nr.	µm	Stackup	Process overview
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A-RS Kupferfolie-018my 330x490mm	50200238	18	VS	1	
C-RAS-FR4-PP-1080-H63-TG150-HF-EM-37B...	50203000	139		2	
C-RAS-FR4-PP-1080-H63-TG150-HF-EM-37B...	50203000	0		3	
		70	L2		
C-RS-FR4-ML-0.152mm-070+070-TG150-HF-...	50203059	152		4	A01
		70	L3		
C-RAS-FR4-PP-1080-H63-TG150-HF-EM-37B...	50203000	124		5	
C-RAS-FR4-PP-1080-H63-TG150-HF-EM-37B...	50203000	0		6	
		70	L4		
C-RS-FR4-ML-0.152mm-070+070-TG150-HF-...	50203059	152		7	A02
		70	L5		
C-RAS-FR4-PP-2116-H53-TG150-HF-EM-37B...	50203001	216		8	
C-RAS-FR4-PP-2116-H53-TG150-HF-EM-37B...	50203001	0		9	
		70	L6		
C-RS-FR4-ML-0.152mm-070+070-TG150-HF-...	50203059	152		10	A03
		70	L7		
C-RAS-FR4-PP-1080-H63-TG150-HF-EM-37B...	50203000	124		11	
C-RAS-FR4-PP-1080-H63-TG150-HF-EM-37B...	50203000	0		12	
		70	L8		
C-RS-FR4-ML-0.152mm-070+070-TG150-HF-...	50203059	152		13	A04
		70	L9		
C-RAS-FR4-PP-1080-H63-TG150-HF-EM-37B...	50203000	139		14	
C-RAS-FR4-PP-1080-H63-TG150-HF-EM-37B...	50203000	0		15	
A-RS Kupferfolie-018my 330x490mm	50200238	18	RS	16	

B00

Thickness after Pressing

B00:

1890 µm

Tol+:

200 µm

Tol-:

200 µm

Dmax:

2090 µm

Dmin:

1690 µm

Thickness over all

0 µm

Tol+:

0 µm

Tol-:

0 µm

Dmax:

0 µm

Dmin:

0 µm

Demand for customer

Thickness (D):

2000 µm

Tol+:

200 µm

Tol-:

200 µm

Dmax:

2200 µm

Dmin:

1800 µm

Measuring point: (05) over SM and galv. Cu; both sides

nominal:

1946 µm

Version 1.2.20.35

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